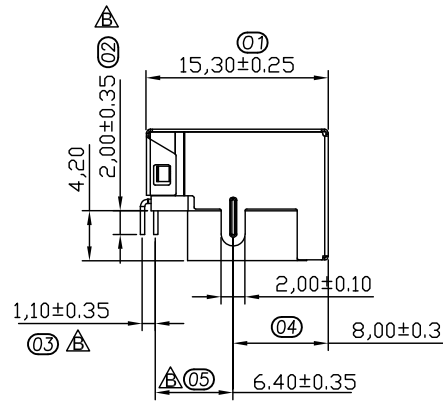
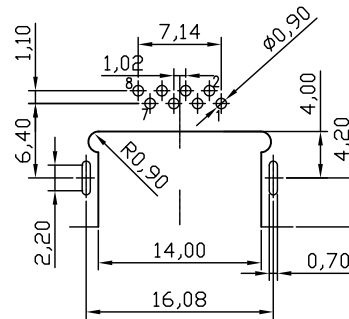
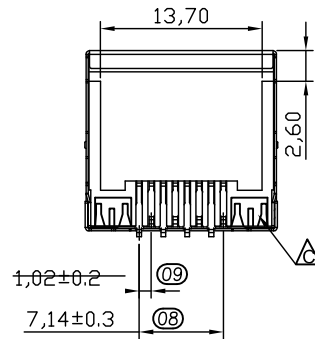
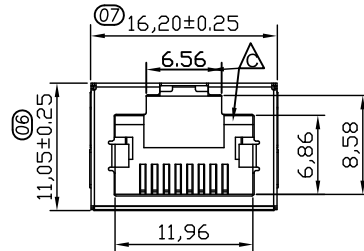
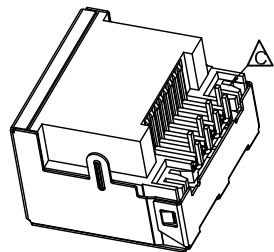
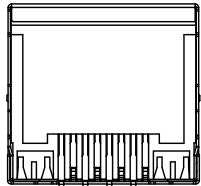


RoHS compliant



脚位尺寸以过孔规为准



PCBLAYOUT TOP VIEW
TOL:±0.05

- NOTES:
1. HOUSING MATERIAL:GLASS FILLED POLYESTER UL94V-0.
 2. CONTACT MATERIAL:COPPER ALLOY,T=0.35.
 3. PLATING: GOLD PLATED ON CONTACT AREA, 100u"MIN. TIN PLATED ON SOLDERING AREA, 50u"MIN. NICKEL PLATED OVERALL.
 4. SHELL:COPPER ALLOY,T=0.20. 30u"MIN. NICKEL PLATED OVERALL.
- ELECTRICAL:
1. VOLTAGE RATING: 125V AC RMS.
 2. CURRENT RAIING: 1.5AMP.
 3. CONTACT RESISTANCE: 30MILLIOHMS MAX.
 4. INSULATION RESISTANCE: 500MEGOHMS MIN @500V DC.
- MECHANICAL:
1. DURRABILITY: 750 CYCLES MIN.
 - 2.INSERTION FORCE : 22N MAX.
 - 3.REMOVAL FORCE(WITHOUT PLUG LOCK) : 22N MAX.
- ENVIRONMENTAL:
1. STORAGE: -40°C~85°C
 2. OPERATION: -40°C~85°C
- *Apply to the EU standards(ROSH)

1. 01~09 FOR QIP DIM.

P/N:RJ58D-8811-101413P

RJ45 SINK DIP SERIES PCB JACK	PACKING TYPE(包装):
POSITIONS(金针位置):	R-BELL(卷带包装)
8-POSITIONS(8P)	P-PVC TRAY(盘装)
CONTACTS(金针根数):	HEIGHT(沉板高度):
8-8CONTACTS(8C)	3-SINK H=4.2(沉板4.2)
PORTS(端口):	COLOR(颜色):
1-E-1X1	1-BLACK(黑色)
SHIELD(屏蔽壳):	PLASTIC(塑料):
1-WITH SHIELD(有屏蔽壳)	4-PC
LED STYLE(LED 颜色类型):	GOLD PLATING(镀金厚度):
6-Without LED(无LED)	1-1U";2-1.5U";3-3U";4-6U";
	5-15U";6-30U";7-50U";

					GENERAL TOLERANCE			DRAWN		Gene Li		2018/10/22		X-SHUN 东莞市祥舜电子科技有限公司 DONGGUAN X-SHUN ELECTRONIC TECHNOLOGY CO., LTD				
					.X ±0.35 X.° ± 2°			CHECKE		HYJ				PART NO. RJ58D-8811-101413P				
A0		NEW DESIGN		2018/10/22		.XX ±0.25 X.° ± 1°			APPROVE						TITLE: RJ45 8P8C SINK H=4.2MM W/SHIELD			
						.XXX ±0.15 .XX° ± 0.5°												
REV	ECN NO	DESCRIPTION		DATE	SIGNATURE	PROJECT			UNIT	mm	SCALE	1:1	SHEET	1/1	REV	A0	DRAWING NO.	RJ58D-88